imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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Zener Diode DE3S062D0L

DE3S062D0L Silicon epitaxial planar type

For ESD protection

- Features
- High ESD
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)
- Marking Symbol:41
- Packaging

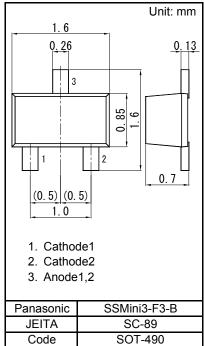
Embossed type (Thermo-compression sealing) 3 000 pcs / reel (standard)

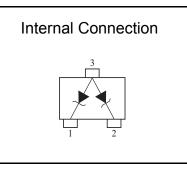
■ Absolute Maximum Ratings Ta = 25 °C

Parameter	Symbol	Rating	Unit	
Total power dissipation ^{*1}	PT 150		mW	
Electrostatic discharge *2	ESD	±30	kV	
Junction temperature	Tj	150	°C	
Operating ambient temperature	Topr	-40 to +85	°C	
Storage temperature	Tstg	-55 to +150	°C	

Note) *1: PT = 150 mW achieved with a printed circuit board. (2 Diode total)

*2: Test method:IEC61000_4_2(C = 150 pF,R = 330 Ω , Contact discharge:10 times)





Parameter	Symbol	Conditions	Min	Тур	Max	Unit		
Zener voltage *1, *2	VZ	IZ = 1 mA	5.89		6.51	V		
Reverse current	IR	VR = 4 V			1.0	μA		
Terminal Capacitance	Ct	VR = 0 V, f = 1 MHz		55		рF		
Temperature coefficient of zener voltage *3	SZ	IZ = 1 mA		2.3		mV/°C		

■ Electrical Characteristics Ta = 25 °C ± 3 °C

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.

2. *1: The temperature must be controlled 25°C for VZ mesurement.

VZ value measured at other temperature must be adjusted to VZ (25°C)

*2: VZ guaranted 20 ms after current flow.

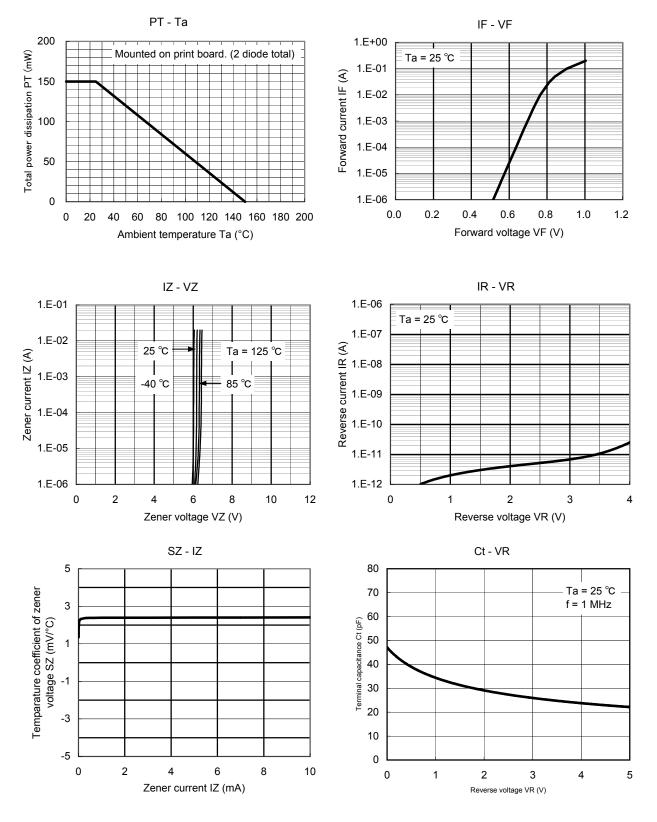
*3: Tj = 25°C to 150°C





Zener Diode DE3S062D0L

Technical Data (reference)



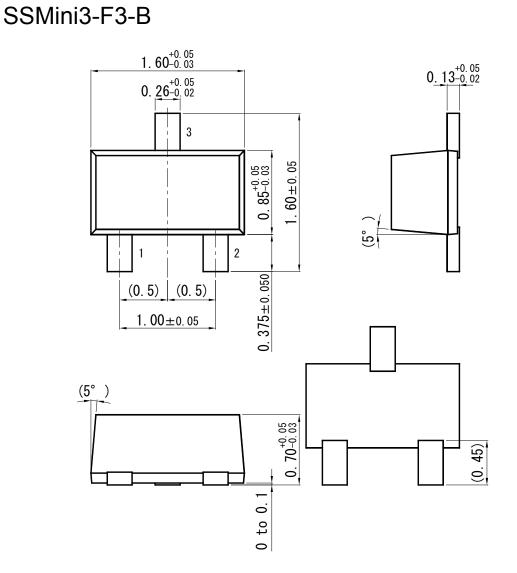
Page 2 of 3

Established : 2010-09-01 Revised : 2013-10-28

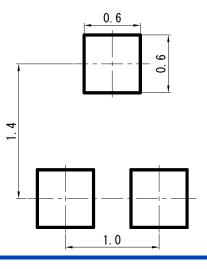


Zener Diode DE3S062D0L

Unit: mm



Land Pattern (Reference) (Unit: mm)



Page 3 of 3

Established : 2010-09-01 Revised : 2013-10-28

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